

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
K. OKAJIMA, et al.

Serial No.: To Be Assigned

Art Unit: To Be Assigned

Filed: Concurrently herewith

Examiner: To Be Assigned

For: Method For Forming Solder-Resist Film

INFORMATION DISCLOSURE STATEMENT
PURSUANT TO 37 C.F.R. §§ 1.56, 1.97 and 1.98

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450



Sir:

In compliance with the dictates of 37 C.F.R. §§ 1.56, 1.97 and 1.98, Applicants hereby submit an Information Disclosure Statement.

It is respectfully requested that the Examiner consider this reference and indicate such consideration by enclosing an appropriately initialed copy of the enclosed form PTO-1449 with the next communication from the Patent Office.

Respectfully submitted,

A handwritten signature in black ink, appearing to read "Donald E. Townsend".

Donald E. Townsend
Reg. No. 22,069

Date: July 31, 2003

TOWNSEND & BANTA
601 Pennsylvania Avenue, N.W.
Suite 900, South Building
Washington, D.C. 20004
(202) 220-3124

INFORMATION DISCLOSURE CITATION <i>(Use several sheets if necessary)</i>	Atty. Docket No. M&M-067-USA-P	Serial No. To be assigned
	Applicants: K. Okajima, et al.	
	Filing Date: July 31, 2003	Group To be assigned

U.S. PATENT DOCUMENTS

*Examiner Initial	Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate

FOREIGN PATENT DOCUMENTS

	Document Number	Date	Country	Class	Subclass	Translation	
						Yes	No

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Page, Etc.)

<div style="border: 1px solid black; width: 100px; height: 100px; margin: 0 auto;"></div>	Japanese Patent Laid-Open No. 222103 (2001)	

EXAMINER	DATE CONSIDERED
-----------------	------------------------

*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.